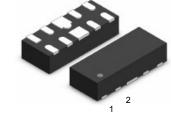
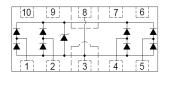
#### **CREATEK Microelectronics**

# **Ultra Low Capacitance ESD TVS Array in DFN2510**

#### **Features**

- 24Watts peak pulse power (tp = 8/20µs)
- DFN2510 Package
- Unidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Low capacitance (0.25pF typical I/O to I/O)
- ESD Protection for high-speed data lines to: IEC 61000-4-2 ±8KV contact ±15KV air IEC 61000-4-4 (EFT) 40A (5/50ns) IEC 61000-4-5 (Lightning) 4A (8/20µs)





#### **Mechanical Data**

- Case: DFN2510 (plastic package). Lead free; RoHS compliant; Halogen free
- Molding Compound Flammability Rating: UL 94 V-0
- **Terminals:** High temperature soldering guaranteed: 260 °C/10 sec. at terminals

## **Applications**

- USB 3.1, USB 3.0, MHL
- HDMI 2.0, Display Port 1.3, eSATA
- Unified Display Interface (UDI)
- Digital Visual Interface (DVI)
- High speed serial interfaces

### **Absolute Maximum Ratings**

Ratings at 25 °C, ambient temperature unless otherwise specified

Parameter	Symbol	Value	Unit
Peak Pulse Power (T <sub>P</sub> =8/20µS)	P <sub>PP</sub>	24	W
ESD contact/air discharge (IEC-61000-4-2)	V <sub>ESD</sub>	8/15	kV
Peak Pulse Current ( t₂ = 8/20µS )	I <sub>PP</sub>	4.0	Α
Junction Temperature	TJ	-55 to +125	${\mathbb C}$
Storage temperature	T <sub>STG</sub>	-55 to +150	°C

#### **Electrical Characteristics**

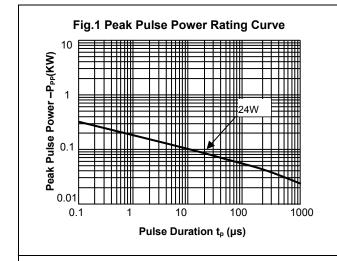
 $(T_A = 25 \, ^{\circ}C \text{ unless otherwise specified})$ 

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Reverse stand-off Voltage	$V_{RWM}$				3.3	V
Holding Voltage	V <sub>H</sub>	I⊤=IH	2.0		3.0	V
Holding Current	lμ		20			mA
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> =3.3V		500		nA
Clamping Voltage	Vc	IPP=3A,tp=8/20µs			4.5	V
Clamping Voltage(TLP)	V <sub>C</sub>	I <sub>PP</sub> =16A, T <sub>P</sub> =100ns		6.3		V
Dynamic Resistance	R <sub>dyn</sub>	I <sub>TLP</sub> =0A~20A		0.25		Ω
Junction Capacitance	Сл	V <sub>R</sub> =0V,f=1MHz, I/O to I/O		0.25		pF
Junction Capacitance	CJ	V <sub>R</sub> =0V,f=1MHz, I/O to GND		0.55		pF

Rev. 1.1 www.crea-tek.com

#### **CREATEK Microelectronics**

# Typical Characteristics ( $T_{amb} = 25 \, ^{\circ}\text{C}$ unless otherwise specified)



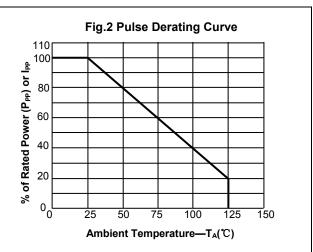
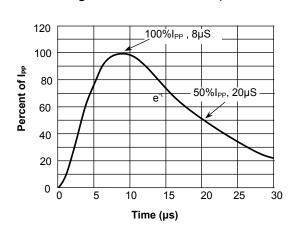


Fig.3 Pulse Waveform-8/20µs



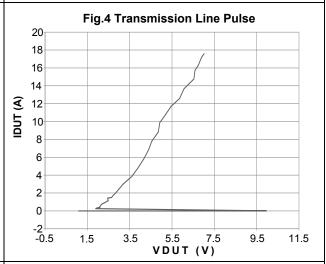
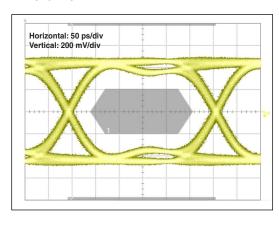
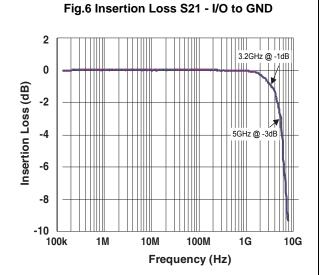


Fig.5 Eye Diagram - HDMI mask at 5Gbps per channel





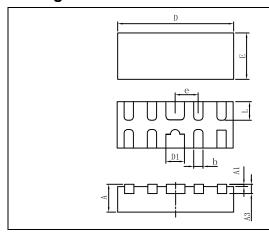
Rev. 1.1 www.crea-tek.com



# CESD2510UC3V3US

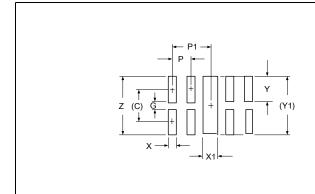
## **CREATEK Microelectronics**

## **Package Dimensions**



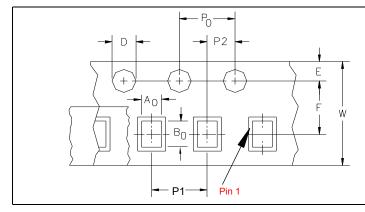
Symbol	Dimensions in millimeters			
Symbol	Min	Nom	Max	
Α	0.45	0.50	0.55	
A1	-	0.02	0.05	
A3	0.10	0.15	0.20	
D	2.45	2.50	2.55	
E	0.95	1.00	1.05	
D1	0.35	0.40	0.45	
b	0.15	0.20	0.25	
е	0.50BS			
L	0.35	0.40	0.45	

### **Pad Dimensions**



	DIMENSIONS			
DIM	INCHES	MILLIMETERS		
С	.034	0.875		
G	.008	0.20		
Р	.020	0.50		
P1	.039	1.00		
Х	.010	0.25		
X1	.018	0.45		
Y	.027	0.675		
Y1	.061	1.55		
Z	.061	1.55		

## **Package Information**



Dimension	Typical	Unit
A0	1.15	
В0	2.65	
D	1.55	
P0	4.00	
P1	4.00	mm
P2	2.00	
E	1.75	
F	3.50	
W	8.00	

## **Ordering information**

Order code	Package	Packaging option	Base quantity	Packaging specification
CESD2510UC3V3US	DFN2510	Tape and reel	3000pcs / reel	EIA STD RS-481

## **Revision history**

Date	Revision	Changes
23-Oct2018	1.0	Initial release
3-Jan2019	1.1	Update

Rev. 1.1 www.crea-tek.com



# CESD2510UC3V3US

#### **CREATEK Microelectronics**

#### **CAUTION / WARNING**

Information in this document is believed to be accurate and reliable. However, CREATEK does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Users should independently evaluate the suitability of and test each product selected for their own applications, and CREATEK assumes no liability whatsoever relating to the choice, selection or use of the CREATEK products and services described herein.

CREATEK reserves the right to change or update, without notice, any information contained in this publication; to change, without notice, the design, construction, processing, or specification of any product; and to discontinue or limit production or distribution of any product.

Information in this document supersedes and replaces all information previously supplied.

Products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an CREATEK product can reasonably be expected to result in personal injury, death or severe property or environmental damage. CREATEK accepts no liability for inclusion and/or use of CREATEK products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

Resale of CREATEK products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by CREATEK for the CREATEK product or service described herein and shall not create or extend in any manner whatsoever, any liability of CREATEK.

CREATEK expressly disclaims all implied warranties regarding the information contained herein, including, but not limited to, any implied warranties of merchantability or fitness for a particular purpose. CREATEK only obligations are those in the CREATEK Standard Terms and Conditions of Sale and in no case will CREATEK be liable for any incidental, indirect, or consequential damages arising from the sale, resale, use, or misuse of its products.

Specifications are subject to change without notice

© Copyright 2009, CREATEK Microelectronics

CREATEK® is a registered trademark of CREATEK Microelectronics

All rights reserved